## **KYCON**

# **D-SUBMINIATURECONNECTORS**

## **Performance Specifications**

**KYCON** Continues its leadership in D-Subminiature connectors by offering a completeline of sizes and options.

## PC99 Colors Available:

- HD15: Blue
- DB15: Gold
- DB25: Burgundy
- DB09: Teal

**Note:** Individual catalog pages and product specifications supersede the general characteristics shown on this page.

## Materials and Finish

#### Shell:

Steel Material, Tin or Nickel Finish, and Indentations (Dimples) on Plug Only **Insert:** 

**Standard:** PBT Thermoplastic, Black Color, 30% Glass Filled, UL94V-0 Rated **Reflow Compatible:** High Temperature Thermoplastic,

Black Color, 30% Glass Filled, UL 94V-0 Rated

## **Contact Material:**

Plug: Brass .040" (1.00mm) Diameter Standard;

.030" (0.76mm) Diameter High Density Socket: Phosphor Bronze or Brass (Precision Formed Contact) Brass (Precision Machined Contact)

See individual spec sheets for more detailed information

#### Contact Finish - (See Plating Options below)

#### **Riveted Insert:**

Brass Material, Nickel Finish

## **Mechanical Characteristics**

#### Durability:

500 Insertion Cycles Min.

## **Operating Temperature:**

-55°C to +105°C

Electrical Characteristics

**Contact Current Rating:** 

- 2A Contact Voltage Rating:
- 30V RMS
- Contact Resistance:
- 13 milliohms Max.

Dielectric Withstanding Voltage:

1000V AC Min. for 1 Minute

InsulationResistance:

1000 Megohms Min. at 500V DC

## **Processing Characteristics**

Wave Soldering Temperature:

PBT Thermoplastic: 245°C for 10 Seconds

High Temperature Thermoplastic: 260°C for 10 Seconds

## **Plating Options**

Designator	Plating Description
Standard	Gold Flash over Nickel on Mating End. Gold Flash or Tin over Nickel on Solder Tails.
30	30µ" Gold over Nickel on Mating End. Tin over Nickel on Solder Tails.

## Termination

## Solder Cup Size:

Standard Density (K85X Series): 18 AWG Max. High Density (K86X Series): 22 AWG Max.